ON Semiconductor

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MOSFET – Power, Single

N-Channel

40 V, 1.0 mΩ, 277 A

NVMFS5C420NL

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C420NLWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit
Drain-to-Source Voltage			V_{DSS}	40	V
Gate-to-Source Voltage			V _{GS}	±20	V
Continuous Drain	Steady State	T _C = 25°C	I _D	277	Α
Current R _{θJC} (Notes 1, 3)		T _C = 100°C		196	
Power Dissipation		T _C = 25°C	P_{D}	146	W
R _{θJC} (Note 1)		T _C = 100°C		73	
Continuous Drain		T _A = 25°C	I _D	45	Α
Current R _{θJA} (Notes 1, 2, 3)	Steady	T _A = 100°C		32	
Power Dissipation	State	T _A = 25°C	P_{D}	3.8	W
R _{θJA} (Notes 1, 2)		T _A = 100°C		1.9	
Pulsed Drain Current	$T_A = 25^{\circ}C, t_p = 10 \mu s$		I _{DM}	900	Α
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +175	°C
Source Current (Body Diode)			I _S	121.4	Α
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 24 A)			E _{AS}	1541	mJ
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			TL	260	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	1.0	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

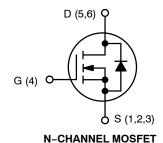
- The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.



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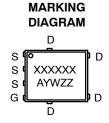
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V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
40 V	1.0 mΩ @ 10 V	277 A
40 V	1.4 mΩ @ 4.5 V	211 A





STYLE 1



XXXXXX = 5C420L

(NVMFS5C420NL) or

420LWF

(NVMFS5C420NLWF)

A = Assembly Location

Y = Year

W = Work Week
ZZ = Lot Traceability

ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	<u>. </u>						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} /				18.5		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V$, $V_{J} = 25^{\circ}C$				10	
		$V_{DS} = 40 \text{ V}$	T _J = 125°C			100	μΑ
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS}	= 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 200 \mu A$		1.2		2.2	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-5.4		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 4.5 V	I _D = 50 A		1.2	1.4	mΩ
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.8	1.0	mΩ
Forward Transconductance	9FS	V _{DS} = 5 V, I _D = 50 A			180		S
CHARGES, CAPACITANCES & GATE RESI	STANCE						
Input Capacitance	C _{ISS}	$V_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}, V_{DS} = 20 \text{ V}$ $V_{GS} = 4.5 \text{ V}, V_{DS} = 32 \text{ V}; I_{D} = 50 \text{ A}$			7020		pF
Output Capacitance	C _{OSS}				3130		
Reverse Transfer Capacitance	C _{RSS}				95		
Total Gate Charge	Q _{G(TOT)}				47		nC
Total Gate Charge	Q _{G(TOT)}	V _{GS} = 10 V, V _{DS} = 32 V; I _D = 50 A			100		
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 32 V; I _D = 50 A			8.7		nC
Gate-to-Source Charge	Q_{GS}				16		
Gate-to-Drain Charge	Q_{GD}				14		
Plateau Voltage	V_{GP}				2.8		V
SWITCHING CHARACTERISTICS (Note 5)							
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 4.5 V, V_{DS} = 32 V, I_{D} = 50 A, R_{G} = 2.5 Ω			37		
Rise Time	t _r				46		ns
Turn-Off Delay Time	t _{d(OFF)}				76		
Fall Time	t _f				31		
DRAIN-SOURCE DIODE CHARACTERISTIC	cs						
Forward Diode Voltage	V_{SD}	VGS - 0 V,	T _J = 25°C		0.8	1.2	
			T _J = 125°C		0.65		V
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, dIS/dt = 100 A/ μ s, I _S = 50 A			75		
Charge Time	t _a				37		ns
Discharge Time	t _b				38		
Reverse Recovery Charge	Q_{RR}				96		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. Pulse Test: pulse width ≤ 300 μs, duty cycle ≤ 2%.

5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS

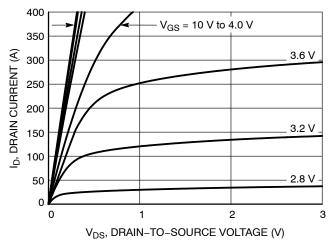


Figure 1. On-Region Characteristics

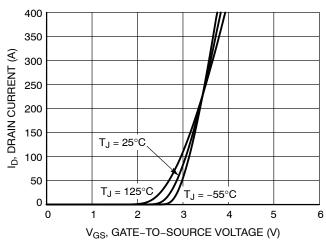


Figure 2. Transfer Characteristics

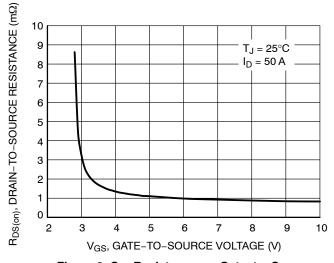


Figure 3. On-Resistance vs. Gate-to-Source Voltage

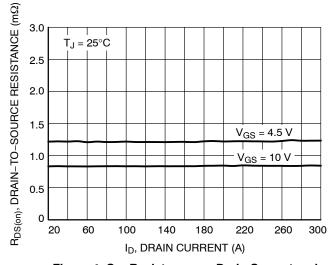


Figure 4. On-Resistance vs. Drain Current and Gate Voltage

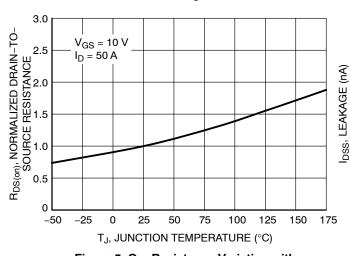


Figure 5. On–Resistance Variation with Temperature

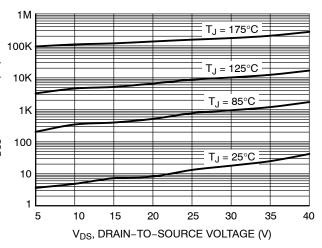
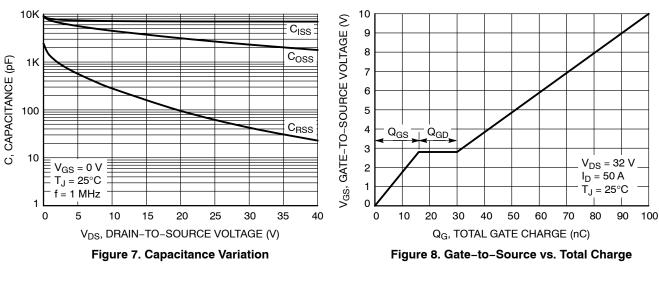


Figure 6. Drain-to-Source Leakage Current vs. Voltage

TYPICAL CHARACTERISTICS



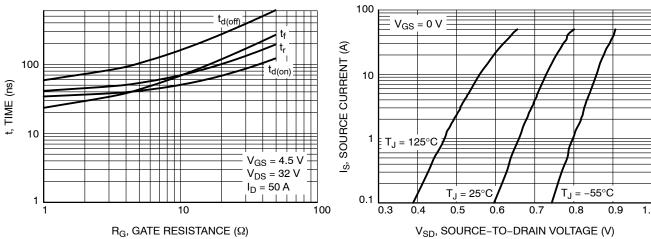


Figure 9. Resistive Switching Time Variation vs. Gate Resistance

ID, DRAIN CURRENT (A)

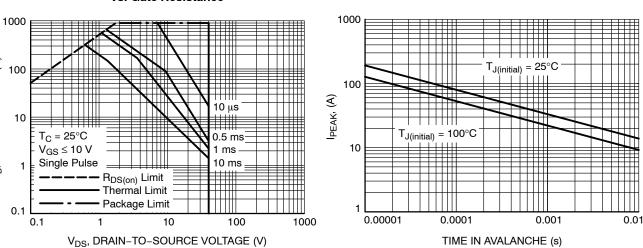


Figure 11. Maximum Rated Forward Biased Safe Operating Area

Figure 12. I_{PEAK} vs. Time in Avalanche

Figure 10. Diode Forward Voltage vs. Current

TYPICAL CHARACTERISTICS

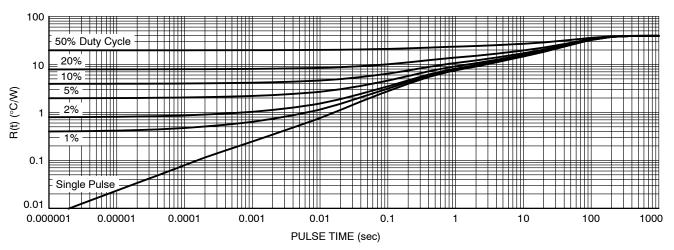


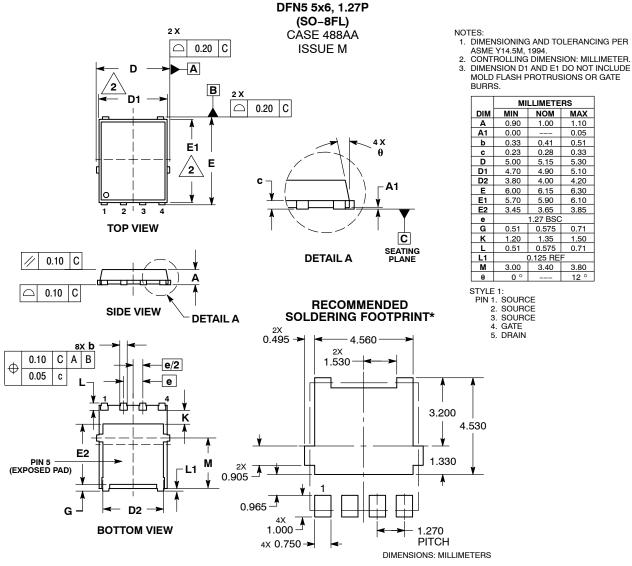
Figure 13. Thermal Characteristics

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFS5C420NLT1G	5C420L	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C420NLWFT1G	420LWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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